



40V DUAL PNP SMALL SIGNAL TRANSISTOR IN SOT363

Features

- BV_{CEO} > -40V
- I_C = -200mA High Collector Current
- Epitaxial Planar Die Construction
- Ideal for Medium Power Amplification and Switching
- Ultra-Small Surface Mount Package
- Complementary NPN Type: MMDT3904
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

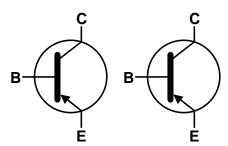
Mechanical Data

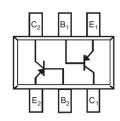
- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound;
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Finish;
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.006 grams (Approximate)

SOT363



Top View





Device Schematic Top View

Ordering Information (Note 4)

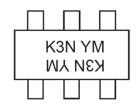
Product	Status	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity Per Reel
MMDT3906-7-F	Active	AFC-Q101	K3N	7	8	3 000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

SOT363



K3N = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} = Year (ex: D = 2016) M or \overline{M} = Month (ex: 9 = September)

Date Code Key

	Year	201	16	2017	2018	2019	2020	2021	202	2 20	23	2024	2025	2026
Ī	Code	D	1	Е	F	G	Н		J	ŀ	<	L	M	N
	Montl	h	Ja	ın Fe	b Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Ī	Code	;	1	2	3	4	5	6	7	8	9	0	N	D



Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	-40	V
Collector-Emitter Voltage	V _{CEO}	-40	V
Emitter-Base Voltage	V_{EBO}	-5	V
Collector Current	Ic	-200	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	200	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

ESD Ratings (Note 6)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

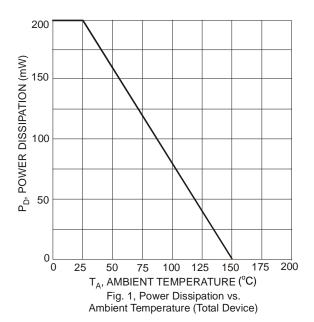
Notes:

^{5.} For the device mounted on minimum recommended pad layout FR-4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

6. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristic and Derating Information





Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

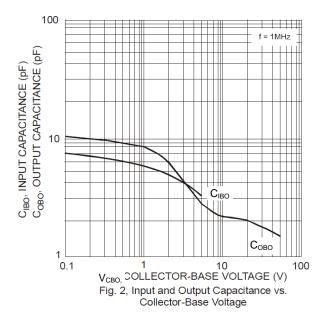
Characteristic	Symbol	Min	Max	Unit	Test Condition
OFF CHARACTERISTICS					
Collector-Base Breakdown Voltage	BV _{CBO}	-40		V	$I_{C} = -10\mu A, I_{E} = 0$
Collector-Emitter Breakdown Voltage (Note 7)	BV_{CEO}	-40	_	V	$I_{C} = -1 \text{mA}, I_{B} = 0$
Emitter-Base Breakdown Voltage	BV _{EBO}	-5	_	V	$I_E = -10\mu A, I_C = 0$
Collector Cut-Off Current	I _{CEX}	_	-50	nA	$V_{CE} = -30V, V_{EB(OFF)} = -3.0V$
Base Cut-Off Current	I_{BL}	_	-50	nA	$V_{CE} = -30V, V_{EB(OFF)} = -3.0V$
ON CHARACTERISTICS (Note 7)					
DC Current Gain	h _{FE}	60 80 100 60 30	 300 	_	$I_{C} = -100\mu A, V_{CE} = -1V$ $I_{C} = -1.0mA, V_{CE} = -1V$ $I_{C} = -10mA, V_{CE} = -1V$ $I_{C} = -50mA, V_{CE} = -1V$ $I_{C} = -100mA, V_{CE} = -1V$
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	_	-0.25 -0.40	V	$I_C = -10\text{mA}$, $I_B = -1\text{mA}$ $I_C = -50\text{mA}$, $I_B = -5\text{mA}$
Base-Emitter Saturation Voltage	V _{BE(SAT)}	-0.65 —	-0.85 -0.95	V	$I_C = -10\text{mA}$, $I_B = -1\text{mA}$ $I_C = -50\text{mA}$, $I_B = -5\text{mA}$
SMALL SIGNAL CHARACTERISTICS				•	
Output Capacitance	Сово	_	4.5	pF	$V_{CB} = -5.0V$, $f = 1.0MHz$, $I_E = 0$
Input Capacitance	C _{IBO}		10	pF	$V_{EB} = -0.5V$, $f = 1.0MHz$, $I_{C} = 0$
Input Impedance	h _{ie}	2	12	kΩ	
Voltage Feedback Ratio	h _{re}	0.1	10	x 10 ⁻⁴	$V_{CE} = -10V, I_{C} = -1.0mA,$
Small Signal Current Gain	h _{fe}	100	400	_	f = 1.0kHz
Output Admittance	h _{oe}	3	60	μS	
Current Gain-Bandwidth Product	f⊤	250		MHz	$V_{CE} = -20V, I_{C} = -10mA,$ f = 100MHz
Noise Figure	N _F	_	4.0	dB	$V_{CE} = -5.0V, I_{C} = -100\mu A,$ $R_{S} = 1.0k\Omega, f = 1.0kHz$
SWITCHING CHARACTERISTICS				•	
Delay Time	t _D		35	ns	
Rise Time	t _R	_	35	ns	$V_{CC} = -3.0V$, $I_{C} = -10mA$,
Storage Time	t _S	_	200	ns	$I_{B1} = I_{B2} = -1.0 \text{mA}$
Fall Time	t _F	_	50	ns	

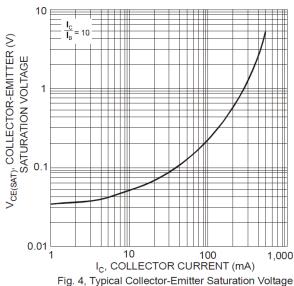
Note:

^{7.} Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%.

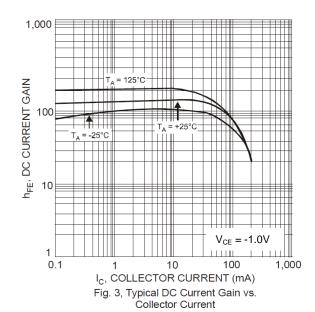


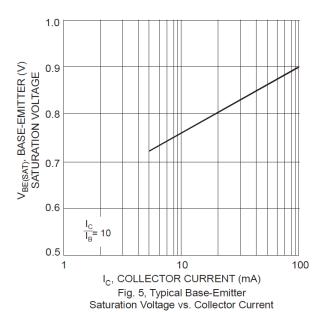
Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)





vs. Collector Current



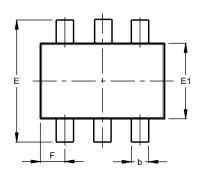


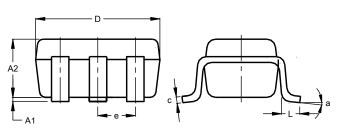


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT363



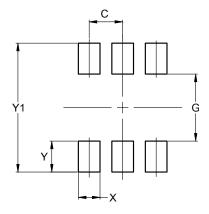


SOT363						
Dim	Min	Max	Тур			
A1	0.00	0.10	0.05			
A2	0.90	1.00	1.00			
b	0.10	0.30	0.25			
С	0.10	0.22	0.11			
D	1.80	2.20	2.15			
Е	2.00	2.20	2.10			
E1	E1 1.15		1.30			
е	C).650 B	SC			
F	0.40	0.45	0.425			
L	L 0.25		0.30			
а	0°	8°				
All Dimensions in mm						

Suggested Pad Layout

 $\label{prop:lease} Please see \ http://www.diodes.com/package-outlines.html for the latest version.$

SOT363



Dimensions	Value (in mm)		
С	0.650		
G	1.300		
Х	0.420		
Y	0.600		
Y1	2.500		



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